Power MOSFET

24 A, 60 V Single N–Channel DPAK

Features

- Low R_{DS(on)}
- High Current Capability
- Avalanche Energy Specified
- NVD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

- LED Lighting and LED Backlight Drivers
- DC–DC Converters
- DC Motor Drivers
- Power Supplies Secondary Side Synchronous Rectification

MAXIMUM RATINGS (T_J = 25° C Unless otherwise specified)

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS} 60		V	
Gate-to-Source Voltage - Continuous			V _{GS}	±20	V	
Gate-to-Source Voltage – Nonrepetitive $(T_P < 10 \ \mu s)$			V _{GS}	± 30	V	
Continuous Drain			Ι _D	24	А	
Current R _{0JC} (Note 1)	State	T _C = 100°C		16		
Power Dissipation $R_{\theta JC}$ (Note 1)	Steady State	T _C = 25°C	P _D	55	W	
Pulsed Drain Current	t _p	= 10 μs	I _{DM}	75	А	
Operating and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)			۱ _S	24	А	
Single Pulse Drain-to-Source Avalanche Energy – Starting T _J = 25° C (V _{DD} = 50 V _{dc} , V _{GS} = 10 V, I _{L(pk)} = 24 A, L = 0.3 mH, R _G = 25Ω)			E _{AS}	86.4	mJ	
Lead Temperature for Soldering Purposes, 1/8" from Case for 10 Seconds			ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit
Junction-to-Case (Drain) Steady State	$R_{\theta JC}$	2.7	°C/W
(Note 1)	$R_{\theta JA}$	58.6	

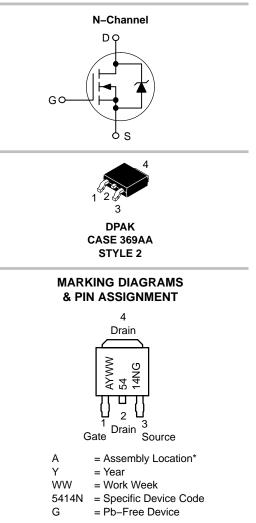
1. Surface mounted on FR4 board using 1 sq in pad size, (Cu Area 1.127 sq in [1 oz] including traces).



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX (Note 1)
60 V	37 mΩ @ 10 V	24 A



* The Assembly Location code (A) is front side optional. In cases where the Assembly Location is stamped in the package, the front side assembly code may be blank.

ORDERING INFORMATION

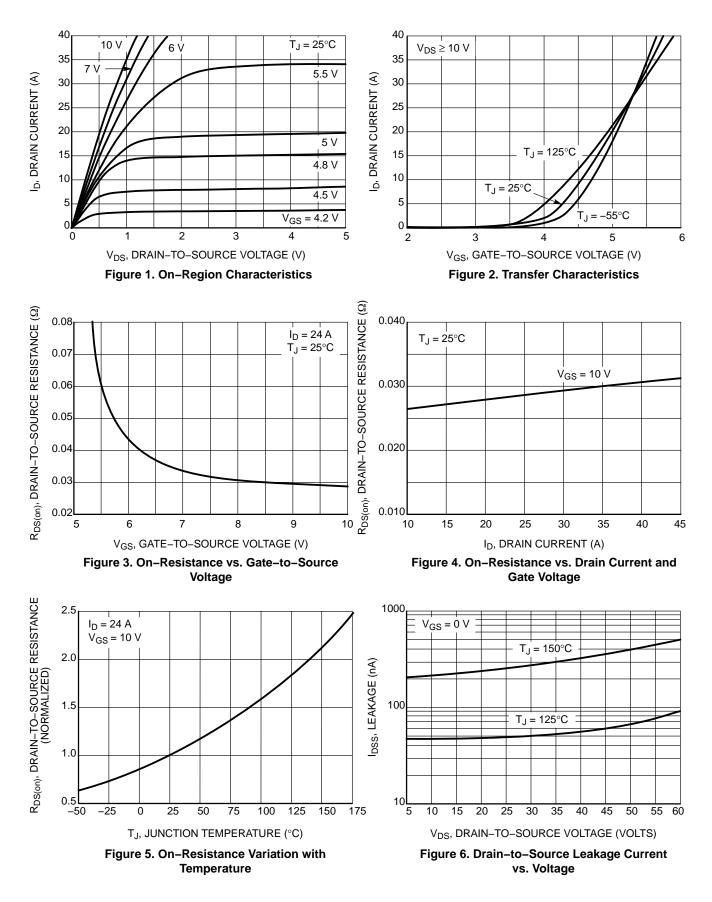
See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C Unless otherwise specified)

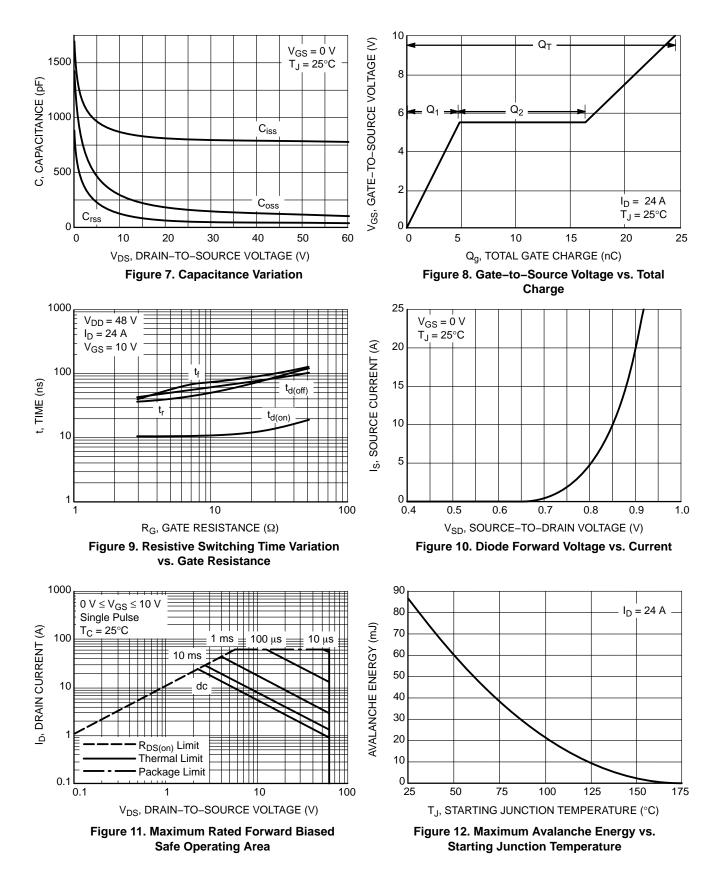
Characteristics	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS						•	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V, I_{D} = 250 \mu A$		60			V
Drain-to-Source Breakdown Voltage Temper- ature Coefficient	V _{(BR)DSS} /T _J				67.3		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V V _{DS} = 60 V	$T_J = 25^{\circ}C$			1.0	μΑ
			T _J = 150°C			50	
Gate-Body Leakage Current	I _{GSS}	V _{DS} = 0 V, \	/ _{GS} = ±20 V			±100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(th)}	V _{GS} = V _{DS} , I _D = 250 μA		2.0	3.2	4.0	V
Negative Threshold Temperature Coefficient	V _{GS(th)} /T _J				0.74		mV/°C
Drain-to-Source On-Voltage	V _{DS(on)}	V _{GS} = 10 V, I _D = 24 A			0.7	1.16	V
		V _{GS} = 10 V, I _C	₀ = 12 A, 150°C		0.7		
Drain-to-Source On-Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 24 \text{ A}$			28.4	37	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _D = 20 A			24		S
CHARGES, CAPACITANCES & GATE RESIST	ANCE				1		
Input Capacitance	C _{iss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1 MHz			800	1200	pF
Output Capacitance	C _{oss}				165		
Transfer Capacitance	C _{rss}				75		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = 10 \text{ V}, V_{DS} = 48 \text{ V},$ $I_D = 24 \text{ A}$			25	48	nC
Threshold Gate Charge	Q _{G(TH)}				1.1		
Gate-to-Source Charge	Q _{GS}				4.8		
Gate-to-Drain Charge	Q _{GD}				11.3		
SWITCHING CHARACTERISTICS, V _{GS} = 10 V	(Note 3)						
Turn-On Delay Time	t _{d(on)}	$V_{GS} = 10 \text{ V}, V_{DD} = 48 \text{ V},$ $I_D = 24 \text{ A}, R_G = 9.1 \Omega$			12		ns
Rise Time	t _r				58		-
Turn–Off Delay Time	t _{d(off)}				47		
Fall Time	t _f				69		
DRAIN-SOURCE DIODE CHARACTERISTICS	;					•	-
Forward Diode Voltage (Note 2)	V _{SD}	$V_{GS} = 0 V$	$T_J = 25^{\circ}C$		0.92	1.15	1.15 V
- · · ·		I _S = 24 A	T _J = 125°C		0.8		
Reverse Recovery Time	t _{rr}	$I_{S} = 24 A_{dc}, V_{GS} = 0 V_{dc}, dI_{S}/dt = 100 A/\mu s$			45.7	1	ns
Charge Time	t _a				31.7	1	
Discharge Time	t _b				14	1	1
Reverse Recovery Stored Charge	Q _{RR}				76		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%. 3. Switching characteristics are independent of operating junction temperatures.

TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES



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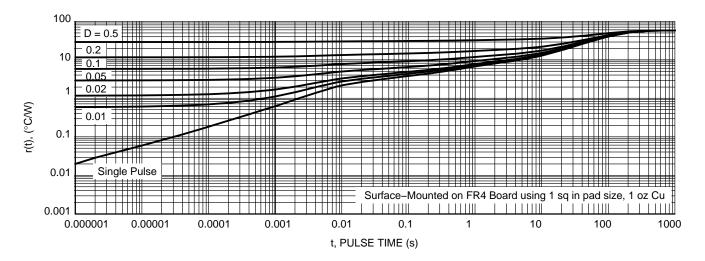


Figure 13. Thermal Response

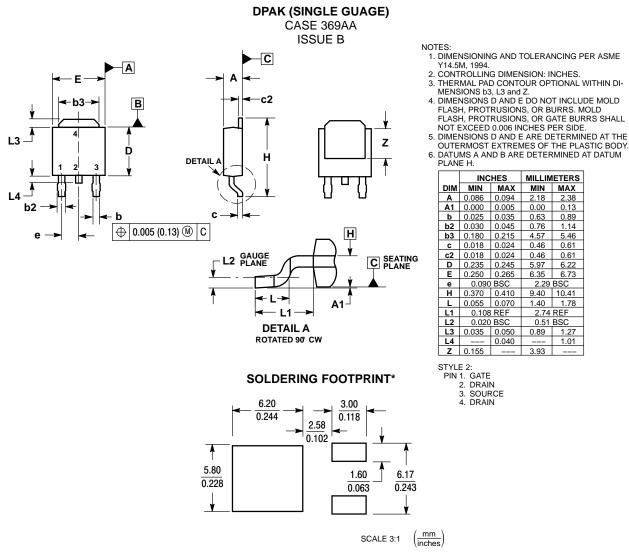
ORDERING INFORMATION

Device	Package	Shipping [†]
NTD5414NT4G	DPAK (Pb–Free)	2500 / Tape & Reel
NVD5414NT4G*	DPAK (Pb–Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NVD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable.

PACKAGE DIMENSIONS



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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